











TPS717





SBVS068I-FEBRUARY 2006-REVISED JANUARY 2016

TPS717

Low-Noise, High-Bandwidth PSRR, Low-Dropout, 150-mA Linear Regulator

Features

- Input Voltage: 2.5 V to 6.5 V
- Available in Multiple Output Versions:
 - Fixed Output with Voltages from 0.9 V to 5 V
 - Adjustable Output Voltage from 0.9 V to 6.2 V
- Ultra-High PSRR:
 - 70 dB at 1 kHz, 67 dB at 100 kHz, and 45 dB at 1 MHz
- **Excellent Load and Line Transient Response**
- Very Low Dropout: 170 mV typical at 150 mA
- Low Noise: 30 μ V_{RMS} typical (100 Hz to 100 kHz)
- Small 5-pin SC-70, 2-mm x 2-mm WSON-6, and 1.5-mm × 1.5-mm WSON-6 Packages

Applications

- Camera Sensor Power
- Mobile Phone Handsets
- PDAs and Smartphones
- Wireless LAN, Bluetooth®

3 Description

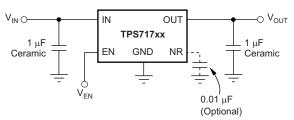
The TPS717 family of low-dropout (LDO), low-power linear regulators offers very high power-supply rejection (PSRR) while maintaining very low 45-µA ground current in an ultra-small, five-pin SOT package. The family uses an advanced BiCMOS process and a PMOS pass device to achieve fast start-up, very low noise, excellent transient response, and excellent PSRR performance. The TPS717 is stable with a 1-µF ceramic output capacitor and uses a precision voltage reference and feedback loop to achieve a worst-case accuracy of 3% over all load, line, process, and temperature variations. The device family is fully specified from $T_J = -40$ °C to 125°C and is offered in a small SOT (SC70-5) package, a 2-mm × 2-mm WSON-6 package with a thermal pad, and a 1.5-mm × 1.5-mm WSON-6 package, which are ideal for small form factor portable equipment (such as wireless handsets and PDAs).

Device Information⁽¹⁾

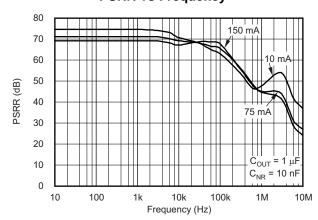
| PART NUMBER | PACKAGE | BODY SIZE (NOM) |
|-------------|----------|-------------------|
| | SC70 (5) | 2.00 mm × 1.25 mm |
| TPS717 | WSON (6) | 2.00 mm × 2.00 mm |
| | WSON (6) | 1.50 mm × 1.50 mm |

(1) For all available package and voltage options, see the orderable addendum at the end of the datasheet.

Typical Application Circuit for Fixed-Voltage Versions



PSRR vs Frequency



Power-Supply Rejection Ratio (V_{IN} – V_{OUT} = 1 V)



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4 Revision History

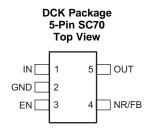
| С | Changes from Revision H (January 2015) to Revision I | Page |
|---|------------------------------------------------------------------------------------------|----------|
| • | Added TI Design | <i>'</i> |
| • | Changed PMOSFET to PMOS in Description section | <i>'</i> |
| • | Added footnote to the Recommended Operating Conditions table | { |
| • | Changed V _{FB} parameter in <i>Electrical Characteristics</i> table | 6 |
| • | Changed units of V _n parameter in <i>Electrical Characteristics</i> table | 6 |
| • | Deleted UVLO parameter minimum specification from Electrical Characteristics table | 6 |
| • | Changed T _A to T _J in x-axis of Figure 7, Figure 10, and Figure 11 | 8 |
| • | Changed second paragraph of Startup and Noise Reduction Capacitor section | 13 |
| • | Changed last bullet in Normal Operation section | 14 |
| • | Changed value of the TJ column in last row of Table 1 | 1 |
| • | Added last sentence to Input and Output Capacitor Requirements section | 16 |
| • | Changed V _{REF} to V _{FB} in Equation 3 | 17 |
| • | Changed definition of z in Table 4 | 23 |



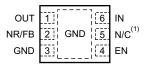
| CI | hanges from Revision G (April 2009) to Revision H | Page |
|----|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------|
| • | Changed pin descriptions throughout Pin Functions table | 4 |
| • | Added ESD Ratings table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section | |
| • | Changed load regulation typical specification from 120 μV to 70 μV to better reflect device performance | 6 |
| • | Changed condition for C _{NR} = none for V _n parameter | 6 |
| • | Changed Figure 1, Figure 2, Figure 3, and Figure 4: removed legend, added call-outs for clarity | <mark>7</mark> |
| • | Changed titles of Figure 15, Figure 17, and Figure 25 | 8 |
| • | Corrected input and output symbols in operational amplifiers in Functional Block Diagrams | 12 |
| • | Changed Undervoltage Lockout (UVLO) section text: reworded for clarity | 14 |
| • | Deleted Reverse Current Protection section | 16 |
| CI | hanges from Revision F (February 2009) to Revision G | Page |
| • | Changed min and max specs for <i>Output accuracy,</i> V _{OUT} ≥ 1.0V | 6 |



5 Pin Configuration and Functions



DRV Package 2-mm × 2-mm, 6-Pin WSON Top View



DSE Package 1.5-mm × 1.5-mm, 6-Pin WSON Top View

| | | | i |
|-------|----|---|--------------------|
| OUT | 1] | 6 | IN |
| GND | 2] | 5 | N/C ⁽¹⁾ |
| NR/FB | 3] | 4 | EN |
| | | | |

(1) N/C = No connection

Pin Functions

| | PIN | | | | |
|------|---------------|---------------|---------------|------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME | DCK (SC70) | DRV (WSON) | DSE (WSON) | I/O | DESCRIPTION |
| EN | 3 | 4 | 4 | I | Driving the enable pin (EN) above $V_{\text{EN(high)}}$ turns on the regulator. Driving this pin below $V_{\text{EN(low)}}$ puts the regulator into standby mode, thereby disabling the output and reducing operating current. |
| FB | 4 | 2 | 3 | Adjustable voltage version only. The voltage at this pin is for error amplifier. A resistor divider from OUT to FB sets the convoltage when in regulation. | |
| GND | 2 | 3 | 2 | _ | Ground |
| IN | 1 | 6 | 6 | 1 | Input to the device. A 0.1-µF to 1-µF capacitor is recommended for better performance. |
| N/C | _ | 5 | 5 | _ | Not connected. This pin can be tied to ground to improve thermal dissipation. |
| NR | 4 | 2 | 3 | _ | Fixed voltage versions only. The noise reduction capacitor filters the noise generated by the internal band gap, thus lowering output noise. |
| OUT | 5 | 1 | 1 | 0 | This pin is the regulated output voltage. A minimum capacitance of 1 μF is required for stability from this pin to ground. |

Product Folder Links: TPS717



6 Specifications

6.1 Absolute Maximum Ratings

over operating temperature range (unless otherwise noted), all voltages are with respect to GND⁽¹⁾

| | | MIN | MAX | UNIT |
|------------------------------------|-------------------|-------------------------|------------------------|------|
| | V _{IN} | -0.3 | 7 | |
| | V_{FB} | -0.3 | 3.6 | |
| Voltage | V_{NR} | -0.3 | 3.6 | V |
| | V _{EN} | -0.3 | $V_{IN} + 0.3 V^{(2)}$ | |
| | V _{OUT} | -0.3 | 7 | |
| Current | I _{OUT} | Interna | ally limited | Α |
| Continuous total power dissipation | P _{DISS} | See Thermal Information | | |
| Operating junction temperature | T_J | – 55 | 150 | °C |
| Storage temperature | T _{stg} | – 55 | 150 | °C |

⁽¹⁾ Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2) V_{EN} absolute maximum rating is V_{IN} + 0.3 V or 7 V, whichever is greater.

6.2 ESD Ratings

| | | | VALUE | UNIT |
|--------------------|-------------------------|---------------------------------------------------------------------|-------|------|
| V | Floatroatatic disaboras | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 (1) | ±2000 | V |
| V _(ESD) | Electrostatic discharge | Charged device model (CDM), per JEDEC specification JESD22-C101 (2) | ±500 | V |

¹⁾ JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

over operating junction temperature range (unless otherwise noted)

| | | MIN | NOM MAX | UNIT |
|------------------|----------------------|------------------|----------|------|
| V_{IN} | Input voltage | 2.5 | 6.5 | V |
| V _{OUT} | Output voltage | 0.9 | 5 | V |
| I _{OUT} | Output current | 0 | 150 | mA |
| V_{EN} | Enable voltage | 0 | V_{IN} | V |
| C _{OUT} | Output capacitor | 1 ⁽¹⁾ | 100 | μF |
| TJ | Junction temperature | -40 | 125 | °C |

⁽¹⁾ When using feedback resistors that are smaller than recommended, the minimum output capacitance must be greater than 5 µF.

6.4 Thermal Information

| | | | TPS717 | | | |
|------------------------|----------------------------------------------|------------|------------|------------|------|--|
| | THERMAL METRIC ⁽¹⁾ | DCK (SC70) | DRV (WSON) | DSE (WSON) | UNIT | |
| | | 5 PINS | 6 PINS | 6 PINS | | |
| $R_{\theta JA}$ | Junction-to-ambient thermal resistance | 279.2 | 71.1 | 190.5 | °C/W | |
| $R_{\theta JC(top)}$ | Junction-to-case (top) thermal resistance | 57.5 | 96.5 | 94.9 | °C/W | |
| R _{0JB} | Junction-to-board thermal resistance | 74.1 | 40.5 | 149.3 | °C/W | |
| ΨЈТ | Junction-to-top characterization parameter | 0.8 | 2.7 | 6.4 | °C/W | |
| ΨЈВ | Junction-to-board characterization parameter | 73.1 | 40.9 | 152.8 | °C/W | |
| R ₀ JC(bot) | Junction-to-case (bottom) thermal resistance | n/a | 10.7 | n/a | °C/W | |

⁽¹⁾ For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report, SPRA953.

Product Folder Links: TPS717

⁽²⁾ JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



6.5 Electrical Characteristics

Over operating temperature range (T $_J$ = -40°C to 125°C), V $_{IN}$ = V $_{OUT(nom)}$ + 0.5 V or 2.5 V, whichever is greater; I $_{OUT}$ = 0.5 mA, V $_{EN}$ = V $_{IN}$, C $_{OUT}$ = 1.0 μ F, C $_{NR}$ = 0.01 μ F, unless otherwise noted. For TPS71701, V $_{OUT}$ = 2.8 V. Typical values are at T $_J$ = 25°C.

| | PARAMETER | | TEST | CONDITIONS | MIN | TYP | MAX | UNIT | |
|-------------------------------|------------------------------------------------------------------------------------|-----------------------------------------------------------------------|------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------|-------|-------------------------|-----------------------|----------------------|--|
| V _{IN} | Input voltage range ⁽¹⁾ | | | | 2.5 | | 6.5 | V | |
| V_{FB} | Feedback pin voltage (| TPS71701) | I _{OUT} = 5 mA | | -2% | 0.793 | 2% | V | |
| \ / | 0.444 | (TPS717xx) | | | 0.9 | | 5.0 | ., | |
| V _{OUT} | Output voltage range | (TPS71701) | | | 0.9 | | 6.5 – V _{DO} | V | |
| | Output accuracy | Nominal | T _J = 25°C | | | ±2.5 | | | |
| V _{OUT} | Output accuracy (V _{OUT} < 1.0 V) | Over V _{IN} , I _{OUT} , temperature ⁽²⁾ | $V_{OUT} + 0.5 \text{ V} \le V_{IN}$ 0 mA $\le I_{OUT} \le 150$ | | -30 | | 30 | mV | |
| | Output accuracy (V _{OUT} ≥ 1.0 V) | Over V _{IN} , I _{OUT} , temperature ⁽²⁾ | $V_{OUT} + 0.5 \text{ V} \le V_{IN}$ 0 mA $\le I_{OUT} \le 150$ | | -3.0% | | 3.0% | | |
| $\Delta V_{OUT(\Delta VIN)}$ | Line regulation ⁽¹⁾ | | $V_{OUT(nom)} + 0.5 \text{ V}$ $I_{OUT} = 5 \text{ mA}$ | ≤ V _{IN} ≤ 6.5 V, | | 125 | | μV/V | |
| $\Delta V_{OUT(\Delta IOUT)}$ | Load regulation | | 0 mA ≤ I _{OUT} ≤ 150 |) mA | | 70 | | μV/mA | |
| V_{DO} | Dropout voltage ⁽³⁾ (V _{IN} = V _{OUT(nom)} - 0.1 V | ′) | I _{OUT} = 150 mA | | | 170 | 300 | mV | |
| I _{LIM} (fixed) | Output current limit (fix | ed output) | $V_{OUT} = 0.9 \times V_{OUT}$ | Γ(nom) | 200 | 325 | 575 | mA | |
| I _{LIM} (adjustable) | Output current limit (TF | PS71701) | $V_{OUT} = 0.9 \times V_{OUT}$ | Г(пот) | 200 | 325 | 575 | mA | |
| 1 | One and this reserved | | $I_{OUT} = 0.1 \text{ mA}$ | | | 45 | 80 | | |
| I _{GND} | Ground pin current | | I _{OUT} = 150 mA | | | 100 | | μA | |
| 01 | 01 11 | | | $2.5 \text{ V} \le \text{V}_{\text{IN}} < 4.5 \text{ V}$ | | 0.20 | 1.5 | μА | |
| SHDN | Shutdown current (I _{GND}) | | $T_J = -40$ °C to 85°C | $4.5 \text{ V} \le \text{V}_{\text{IN}} \le 6.5 \text{ V}$ | | 0.90 | | | |
| I _{FB} | Feedback pin current (| TPS71701) | | | | 0.02 | 1.0 | μA | |
| 10 | Power-supply rejection ratio | | V _{IN} = 3.8 V, V _{OUT} = 2.8 V, I _{OUT} = 150 mA | f = 100 Hz | | 70 | | dB | |
| | | | | f = 1 kHz | | 70 | | | |
| PSRR | | | | f = 10 kHz | | 67 | | | |
| PSRR | | | | f = 100 kHz | | 67 | | | |
| | | | | f = 1 MHz | | 45 | | | |
| | | | BW = 100 Hz to | C _{NR} = none | | 95 × V _{OUT} | | | |
| ., | | | 100 kHz, | C _{NR} = 0.001 µF | | 25 × V _{OUT} | | ., | |
| V_n | Output noise voltage | | $V_{IN} = 3.8 \text{ V},$ $V_{OUT} = 2.8 \text{ V},$ | C _{NR} = 0.01 μF | | 12.5 × V _{OUT} | | μV _{RMS} /V | |
| | | | I _{OUT} = 10 mA | $C_{NR} = 0.1 \ \mu F$ | | 11.5 × V _{OUT} | | | |
| | Chartup time | | $V_{OUT} = 90\%$ $V_{OUT(nom)}$ | $0.9 \text{ V} \le \text{V}_{\text{OUT}} \le 1.6 \text{V}, \text{ C}_{\text{NR}}$ = 0.001 µF | | 0.700 | | | |
| t _{STR} | Startup time | Startup time $ \begin{array}{c} R_L = 19 \\ C_{OUT} = 1 \end{array} $ | | $1.6 \text{ V} < \text{V}_{\text{OUT}} < \text{V}_{\text{MAX}},$ $C_{\text{NR}} = 0.01 \mu\text{F}$ | | 0.160 | | ms | |
| Vengue | Enable high (enabled) | | V _{IN} ≤ 5.5 V | | 1.2 | | 6.5(4) | V | |
| V _{EN(high)} | Enable mgn (enabled) | | $5.5 \text{ V} < \text{V}_{\text{IN}} \le 6.5 \text{ V}$ | V | 1.25 | | 6.5 | v | |
| V _{EN(low)} | Enable low (shutdown) | ı | | | 0 | | 0.4 | V | |
| I _{EN(high)} | Enable pin current, ena | abled | EN = 6.5 V | | | 0.02 | 1.0 | μΑ | |
| UVLO | Undervoltage lockout | | V _{IN} rising | | | 2.45 | 2.49 | V | |
| | Hysteresis | | V _{IN} falling | | | 150 | | mV | |
| т | Thermal shutdown tem | inerature | Shutdown, tempe | rature increasing | | 160 | | °C | |
| T _{sd} | memiai silutuowii telli | polatule | Reset, temperature decreasing | | | 140 | | | |
| T_J | Operating junction tem | perature | | | -40 | | 125 | °C | |

⁽¹⁾ Minimum $V_{IN} = V_{OUT} + V_{DO}$ or 2.5 V, whichever is greater.

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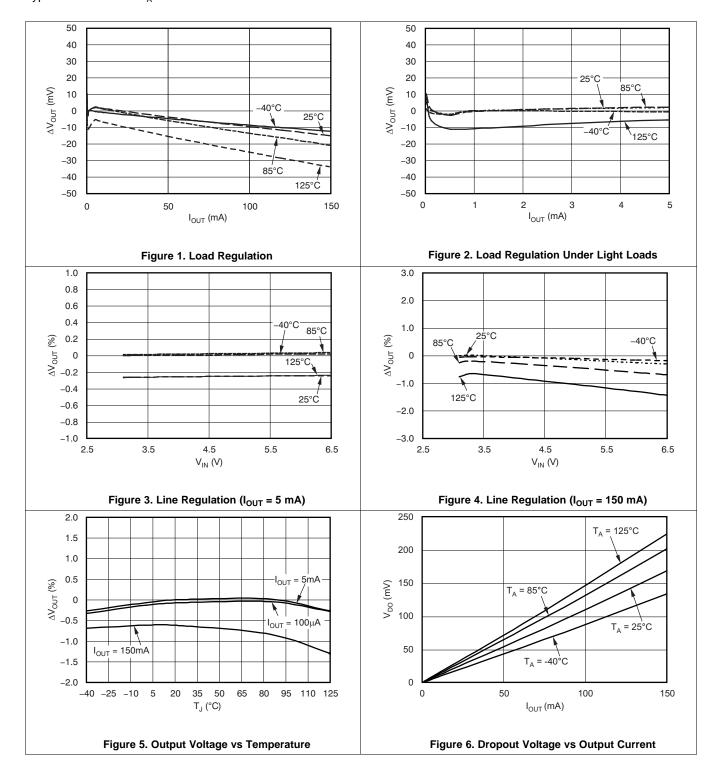
Does not include external resistor tolerances.

⁽³⁾ V_{DO} is not measured for devices with $V_{OUT(nom)}$ < 2.6 V because the minimum V_{IN} is 2.5 V. (4) Maximum $V_{EN(high)} = V_{IN} + 0.3$ or 6.5 V, whichever is smaller.



6.6 Typical Characteristics

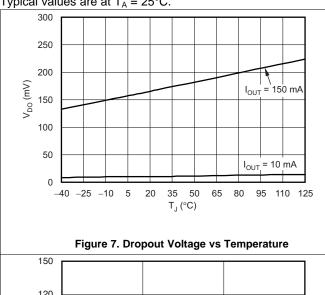
Over operating temperature range ($T_J = -40^{\circ}C$ to 125°C), $V_{IN} = V_{OUT(nom)} + 0.5$ V or 2.5 V, whichever is greater; $I_{OUT} = 0.5$ mA, $V_{EN} = V_{IN}$, $C_{OUT} = 1$ μ F, $C_{NR} = 0.01$ μ F, unless otherwise noted. For the adjustable version (TPS71701,) $V_{OUT} = 2.8$ V. Typical values are at $T_A = 25^{\circ}C$.



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Over operating temperature range (T_J = -40° C to 125°C), V_{IN} = $V_{OUT(nom)}$ + 0.5 V or 2.5 V, whichever is greater; I_{OUT} = 0.5 mA, V_{EN} = V_{IN} , C_{OUT} = 1 μ F, C_{NR} = 0.01 μ F, unless otherwise noted. For the adjustable version (TPS71701,) V_{OUT} = 2.8 V. Typical values are at T_A = 25°C.



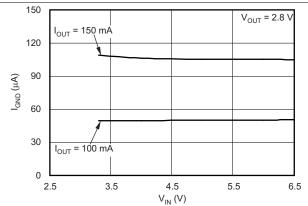
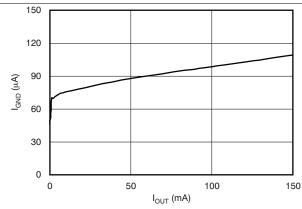


Figure 8. Ground Pin Current vs Input Voltage



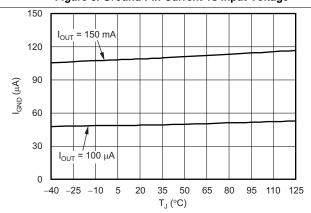
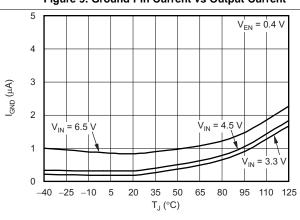


Figure 9. Ground Pin Current vs Output Current

Figure 10. Ground Pin Current vs Temperature (Enabled)



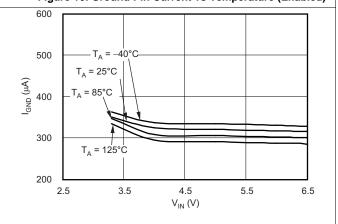
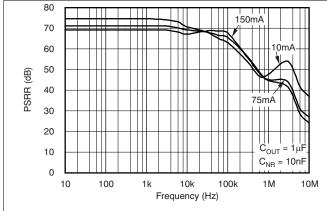


Figure 11. Ground Pin Current vs Temperature (Disabled)

Figure 12. Current Limit vs Input Voltage



Over operating temperature range (T_J = -40° C to 125°C), V_{IN} = $V_{OUT(nom)}$ + 0.5 V or 2.5 V, whichever is greater; I_{OUT} = 0.5 mA, V_{EN} = V_{IN} , C_{OUT} = 1 μ F, C_{NR} = 0.01 μ F, unless otherwise noted. For the adjustable version (TPS71701,) V_{OUT} = 2.8 V. Typical values are at T_A = 25°C.



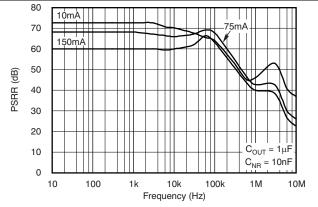
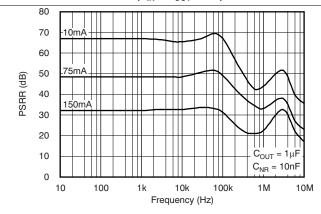


Figure 13. Power-Supply Ripple Rejection vs Frequency $(V_{IN} - V_{OUT} = 1 V)$

Figure 14. Power-Supply Ripple Rejection vs Frequency $(V_{IN} - V_{OUT} = 0.5 \text{ V})$



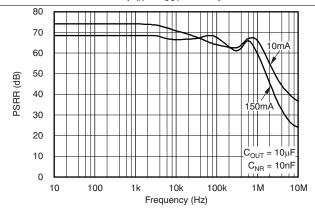
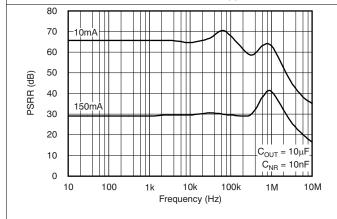


Figure 15. Power-Supply Ripple Rejection vs Frequency in Dropout Conditions ($V_{IN} - V_{OUT} = 0.25 \text{ V}$)

Figure 16. Power-Supply Ripple Rejection vs Frequency $(V_{IN} - V_{OUT} = 1 V)$



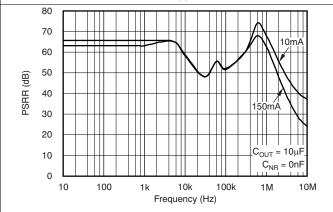


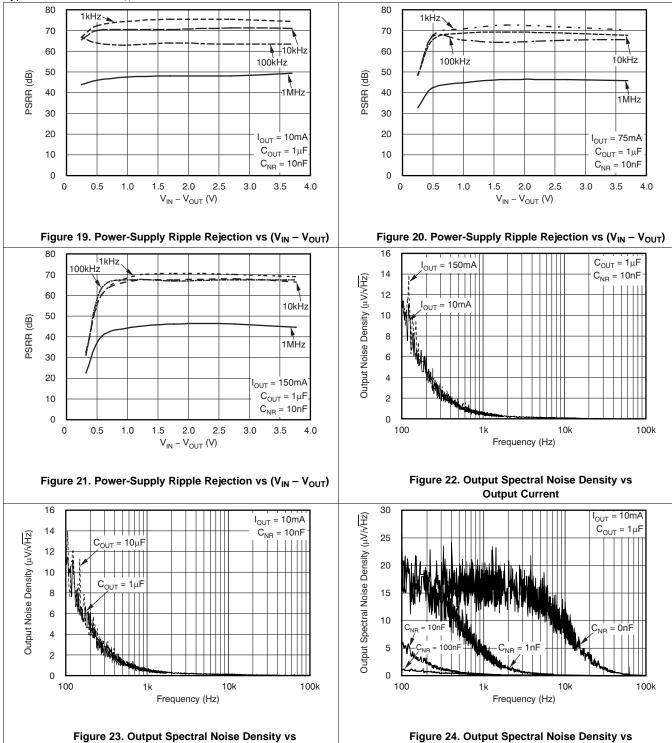
Figure 17. Power-Supply Ripple Rejection vs Frequency in Dropout Conditions ($V_{IN} - V_{OUT} = 0.25 \text{ V}$)

Figure 18. Power-Supply Ripple Rejection vs Frequency $(V_{IN} - V_{OUT} = 1 V)$

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Over operating temperature range ($T_J = -40^{\circ}C$ to 125°C), $V_{IN} = V_{OUT(nom)} + 0.5$ V or 2.5 V, whichever is greater; $I_{OUT} = 0.5$ mA, $V_{EN} = V_{IN}$, $C_{OUT} = 1$ μ F, $C_{NR} = 0.01$ μ F, unless otherwise noted. For the adjustable version (TPS71701,) $V_{OUT} = 2.8$ V. Typical values are at $T_A = 25^{\circ}C$.



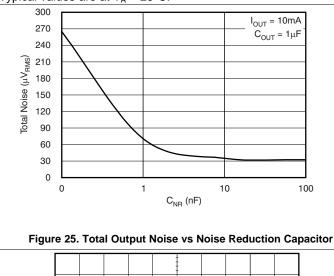
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Output Capacitance

Noise Reduction



Over operating temperature range (T $_J$ = -40°C to 125°C), V_{IN} = $V_{OUT(nom)}$ + 0.5 V or 2.5 V, whichever is greater; I_{OUT} = 0.5 mA, V_{EN} = V_{IN} , C_{OUT} = 1 μ F, C_{NR} = 0.01 μ F, unless otherwise noted. For the adjustable version (TPS71701,) V_{OUT} = 2.8 V. Typical values are at $T_A = 25$ °C.



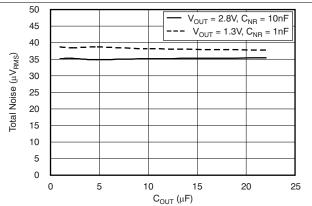
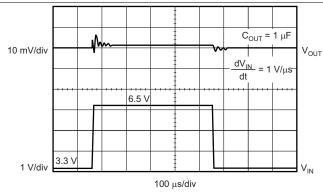


Figure 26. Total Output Noise vs Output Capacitance



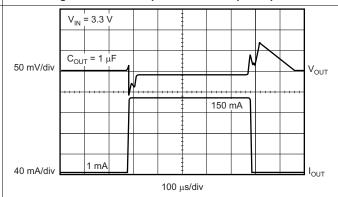
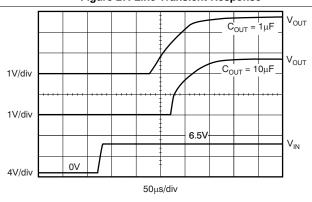




Figure 28. Load Transient Response



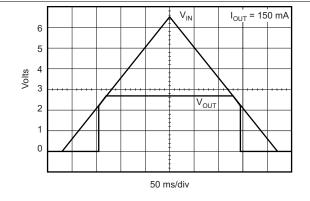


Figure 29. Turn-On Response

Figure 30. Power-Up and Power-Down



7 Detailed Description

7.1 Overview

The TPS717 family of low-dropout (LDO) regulators combines the high performance required by many RF and precision analog applications with ultra-low current consumption. High PSRR is provided by a high-gain, high-bandwidth error loop with good supply rejection with very low headroom ($V_{IN} - V_{OUT}$). Fixed voltage versions provide a noise reduction pin to bypass noise generated by the band-gap reference and to improve PSRR. A quick-start circuit fast-charges this capacitor at startup. The combination of high performance and low ground current also make the TPS717 family of devices an excellent choice for battery-powered applications. All versions have thermal and overcurrent protection.

7.2 Functional Block Diagrams

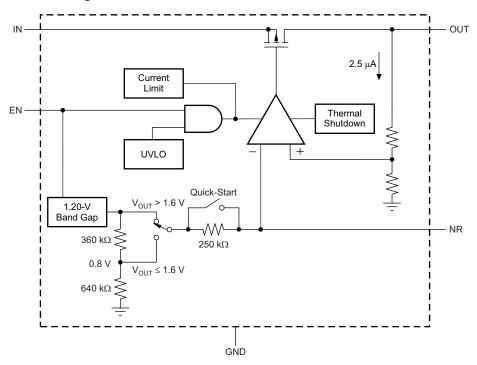


Figure 31. Fixed Voltage Versions



Functional Block Diagrams (continued)

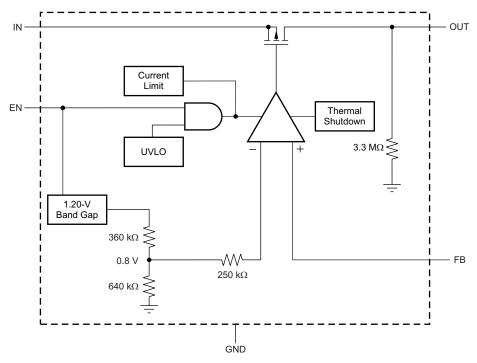


Figure 32. Adjustable Voltage Version

7.3 Feature Description

7.3.1 Internal Current Limit

The TPS717 internal current limit helps protect the regulator during fault conditions. During current limit, the output sources a fixed amount of current that is largely independent of output voltage. For reliable operation, do not operate the device in a current-limit state for extended periods of time.

The PMOS pass element in the TPS717 has a built-in body diode that conducts current when the voltage at OUT exceeds the voltage at IN. This current is not limited, so if extended reverse voltage operation is anticipated, external limiting may be appropriate.

7.3.2 Shutdown

The enable pin (EN) is active high and compatible with standard and low voltage, TTL-CMOS levels. When shutdown capability is not required, EN can be connected to IN.

7.3.3 Startup and Noise Reduction Capacitor

Fixed voltage versions of the TPS717 use a quick-start circuit to fast-charge the noise reduction capacitor, C_{NR} , if present (see Figure 31). This circuit allows the combination of very low output noise and fast start-up times. The NR pin is high impedance, so a low-leakage C_{NR} capacitor must be used; most ceramic capacitors are appropriate in this configuration.

Note that for fastest startup, apply V_{IN} first, then drive the enable pin high. If EN is tied to IN, startup is somewhat slower. The quick-start switch is closed for approximately 135 μ s. To ensure that C_{NR} is fully charged during the quick-start time, use a 0.01- μ F or smaller capacitor.



Feature Description (continued)

For output voltages below 1.6 V, a voltage divider on the band-gap reference voltage is employed to optimize output regulation performance for lower output voltages. This configuration results in an additional resistor in the quick-start path and combined with the noise reduction capacitor (C_{NR}) results in slower start-up times for output voltages below 1.6 V.

Equation 1 approximates the start-up time as a function of C_{NR} for output voltages below 1.6 V:

$$t_{START} = 160\mu s + (540 \frac{\mu s}{nF} \times C_{NR} nF)\mu s$$
(1)

7.3.4 Undervoltage Lockout (UVLO)

The TPS717 uses an undervoltage lockout circuit to keep the output shut off until the internal circuitry is operating properly. The UVLO circuit has a limited glitch immunity so undershoot transients are typically ignored on the input if these transients are less than 5 µs in duration. When the input is lower than 1.4 V, the UVLO circuit may not have enough headroom to keep the output fully off.

7.3.5 Minimum Load

The TPS717 is stable with no output load. Traditional PMOS LDO regulators suffer from lower loop gain at very light output loads. The TPS717 employs an innovative low-current mode circuit to increase loop gain under very light or no-load conditions, resulting in improved output voltage regulation performance down to zero output current.

7.3.6 Thermal Protection

Thermal protection disables the output when the junction temperature rises to approximately 160°C, allowing the device to cool. When the junction temperature cools to approximately 140°C the output circuitry is again enabled. Depending on power dissipation, thermal resistance, and ambient temperature, the thermal protection circuit can cycle on and off. This cycling limits the dissipation of the regulator, protecting it from damage because of overheating.

Any tendency to activate the thermal protection circuit indicates excessive power dissipation or an inadequate heatsink. For reliable operation, limit junction temperature to 125°C maximum. To estimate the margin of safety in a complete design (including heatsink), increase the ambient temperature until the thermal protection is triggered; use worst-case loads and signal conditions. For good reliability, trigger thermal protection at least 35°C above the maximum expected ambient condition of a particular application. This configuration produces a worst-case junction temperature of 125°C at the highest expected ambient temperature and worst-case load.

The internal protection circuitry of the TPS717 is designed to protect against overload conditions. This circuitry is not intended to replace proper heatsinking. Continuously running the TPS717 into thermal shutdown degrades device reliability.

7.4 Device Functional Modes

7.4.1 Normal Operation

The device regulates to the nominal output voltage under the following conditions:

- The input voltage has previously exceeded the UVLO rising voltage and has not decreased below the UVLO falling threshold
- The input voltage is greater than the nominal output voltage added to the dropout voltage
- The enable voltage has previously exceeded the enable rising threshold voltage and has not decreased below the enable falling threshold
- The output current is less than the current limit
- The device junction temperature is less than or equal to the maximum specified operating junction temperature

Product Folder Links: TPS717



Device Functional Modes (continued)

7.4.2 Dropout Operation

If the input voltage is lower than the nominal output voltage plus the specified dropout voltage, but all other conditions are met for normal operation, the device operates in dropout mode. In this condition, the output voltage is the same as the input voltage minus the dropout voltage. The transient performance of the device is significantly degraded because the pass device is in a triode state and no longer controls the current through the LDO. Line or load transients in dropout can result in large output voltage deviations.

7.4.3 Disabled

The device is disabled under the following conditions:

- The input voltage is less than the UVLO falling voltage, or has not yet exceeded the UVLO rising threshold.
- The enable voltage is less than the enable falling threshold voltage or has not yet exceeded the enable rising threshold.
- The device junction temperature is greater than the thermal shutdown temperature.

Table 1 shows the conditions that lead to the different modes of operation.

Table 1. Device Functional Mode Comparison

| OPERATING MODE | PARAMETER | | | | | | |
|--------------------------------------------------------|------------------------------------------------------|-------------------------|---------------------|------------------------|--|--|--|
| OPERATING MODE | V _{IN} | V _{EN} | I _{OUT} | T _J | | | |
| Normal mode | $V_{IN} > V_{OUT(nom)} + V_{DO}$ and $V_{IN} > UVLO$ | $V_{EN} > V_{EN(high)}$ | $I_{OUT} < I_{LIM}$ | T _J < 125°C | | | |
| Dropout mode | $UVLO < V_{IN} < V_{OUT(nom)} + V_{DO}$ | $V_{EN} > V_{EN(high)}$ | | T _J < 125°C | | | |
| Disabled mode (any true condition disables the device) | V _{IN} < UVLO - V _{hys} | $V_{EN} < V_{EN(low)}$ | _ | T _J > 160°C | | | |

Product Folder Links: TPS717



8 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Application Information

The TPS717 belongs to a family of new generation LDO regulators that use innovative circuitry to achieve ultrawide bandwidth and high loop gain, resulting in extremely high PSRR at very low headroom ($V_{IN} - V_{OUT}$). Fixed voltage versions provide a noise reduction pin to bypass noise generated by the band-gap reference and to improve PSRR when a quick-start circuit fast-charges this capacitor. These features, combined with low noise, enable, low ground pin current, and ultra-small packaging, make this part ideal for many applications. This family of regulators offers sub-band-gap output voltages, current limit, and thermal protection, and is fully specified from -40° C to 125° C.

8.1.1 Transient Response

As with any regulator, increasing the size of the output capacitor reduces overshoot or undershoot magnitude but increases duration of the transient. The TPS717 has an ultra-wide loop bandwidth that allows it to respond quickly to load transient events. As with any regulator, the loop bandwidth is finite and the initial transient voltage peak is controlled by the sizing of the output capacitor. Typically, larger output capacitors reduce the peak and also reduce the bandwidth of the LDO, thus slowing the response time.

8.1.2 Input and Output Capacitor Requirements

Although an input capacitor is not required for stability, good analog design practice is to connect a 0.1-µF or larger low equivalent series resistance (ESR) capacitor from IN to GND near the regulator. This capacitor counteracts reactive input sources and improves transient response, noise rejection, and ripple rejection. A higher-value capacitor may be necessary if large, fast rise-time load transients are anticipated or if the device is located several inches from the power source. If source impedance is not sufficiently low, a 0.1-µF input capacitor may be necessary to ensure stability.

The TPS717 is designed to be stable with ceramic output capacitors of values 1 μ F or larger. The X5R- and X7R-type capacitors are best because they have minimal variation in value and ESR over temperature. The maximum ESR of the output capacitor must be less than 1 Ω . The minimum output capacitance is increased to 5 μ F or larger if using an R₂ value outside of the range of 160 k Ω to 320 k Ω .

8.1.3 Dropout Voltage

The TPS717 uses a PMOS pass transistor to achieve low dropout. When $(V_{IN} - V_{OUT})$ is less than the dropout voltage (V_{DO}) , the PMOS pass device is in its linear region of operation and the input-to-output resistance is the R_{DSon} of the PMOS pass element. V_{DO} scales approximately with output current because the PMOS device functions as a resistor in dropout.

As with any linear regulator, PSRR and transient response are degraded when $(V_{IN} - V_{OUT})$ approaches dropout. This effect is illustrated in Figure 15 through Figure 17 in the *Typical Characteristics* section.

Product Folder Links: TPS717



Application Information (continued)

8.1.4 Output Noise

In most LDOs, the band gap is the dominant noise source. If a noise reduction capacitor (C_{NR}) is used with the TPS717, the band gap does not contribute significantly to noise. Instead, noise is dominated by the output resistor divider and the error amplifier input. To minimize noise in a given application, use a 0.01- μ F (minimum) noise reduction capacitor; for the adjustable version, smaller value resistors in the output resistor divider reduce noise. A parallel combination that gives 2.5 μ A of divider current has the same noise performance as a fixed voltage version.

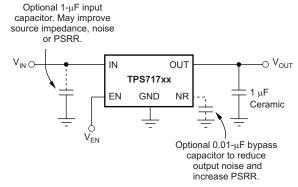
Equation 2 approximates the total noise referred to the feedback point (FB pin) when $C_{NR} = 0.01 \mu F$:

$$V_{N} = 11.5 \frac{\mu V_{RMS}}{V} \times V_{OUT}$$
 (2)

8.2 Typical Applications

8.2.1 Application for Fixed Voltage Versions and Adjustable Voltage Version

Figure 33 shows the basic circuit connections for the fixed voltage options. Figure 34 gives the connections for the adjustable output version (TPS71701). **Note that the NR pin is not available on the adjustable version**.



Optional 1-µF input capacitor. May improve source impedance, noise or PSRR.

V_{IN} OUT

TPS71701

EN GND FB

R₁

1 µF

Ceramic

Figure 33. Typical Application Circuit (Fixed Voltage Versions)

Figure 34. Typical Application Circuit (Adjustable Voltage Version)

8.2.1.1 Design Requirements

Table 2 summarizes the design requirements for Figure 36.

Table 2. Design Parameters

| PARAMETER | DESIGN REQUIREMENT |
|------------------------------------|-----------------------------|
| Input voltage | 3.3 V, ±10% |
| Output voltage | 2.8 V, ±5% |
| Output current | 100 mA typical, 150 mA peak |
| Output voltage transient deviation | 5% |
| Maximum ambient temperature | 85°C |

8.2.1.2 Detailed Design Procedure

For the adjustable version (TPS71701), the NR pin is replaced with a feedback (FB) pin. The voltage on this pin sets the output voltage and is determined by the values of R_1 and R_2 . The values of R_1 and R_2 can be calculated for any voltage using the formula given in Equation 3:

$$R_1 = R_2 \times \left(\frac{V_{OUT}}{V_{FB} - 1}\right) \tag{3}$$

The value of R_2 directly impacts the operation of the device and must be chosen in the range of approximately 160 k Ω to 320 k Ω . Sample resistor values for common output voltages are shown in Table 3.

Table 3. Sample 1% Resistor Values for Common Output Voltages

| V _{OUT} | R ₁ | R ₂ |
|------------------|----------------|----------------|
| 1 | 80.6 kΩ | 324 kΩ |
| 1.2 | 162 kΩ | 324 kΩ |
| 1.5 | 294 kΩ | 332 kΩ |
| 1.8 | 402 kΩ | 324 kΩ |
| 2.5 | 665 kΩ | 316 kΩ |
| 3.3 | 1.02 ΜΩ | 324 kΩ |
| 5 | 1.74 ΜΩ | 332 kΩ |

8.2.1.3 Application Curve

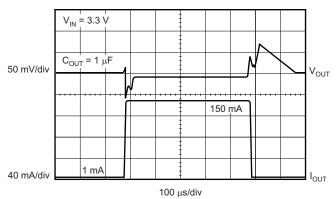


Figure 35. Load Transient Response

8.2.2 Powering a PLL Integrated on an SOC

Figure 36 shows the TPS71701 powering a phase-locked loop (PLL) that is integrated into a system-on-a-chip (SOC).

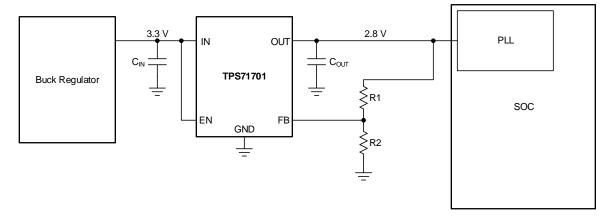


Figure 36. Typical Application Circuit: PLL on an SOC

Use the input and output capacitors to ensure the voltage transient requirements. A $1-\mu F$ input and $1-\mu F$ output capacitor are selected to maximize the capacitance and minimize capacitor size.

 R_2 is chosen to be 158 k Ω for optimal noise and PSRR, and by Equation 4, R_1 is selected to be 402 k Ω . Both R_1 and R_2 must be 1% tolerance resistors to meet the dc accuracy specification over line, load, and temperature.

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8.3 Do's and Don'ts

Do place at least one 1-µF ceramic capacitor as close as possible in the range of the regulator.

Do not place the output capacitor more than 10 mm away from the regulator.

Do not place any components in the feedback loop except for the output capacitor and feedback resistors.

Do not exceed the device absolute maximum ratings.

Do not float the enable (EN) pin.

9 Power Supply Recommendations

The TPS717 is designed to operate from an input voltage between 2.5 V and 6.5 V. The input supply must provide adequate headroom for the device to operate in a normal mode of operation.

Connect a low output impedance power supply directly to the IN pin of the TPS717. Inductive impedances between the input supply and the IN pin can create significant voltage excursions at the IN pin during startup or load transient events. If inductive impedances are unavoidable, use an input capacitor. To increase the overall PSRR of the power solution, use a pi-filter before the input of the LDO or after the feedback network of the LDO.



10 Layout

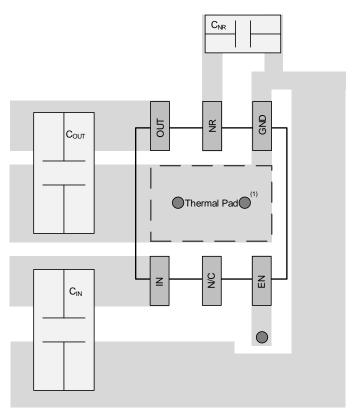
10.1 Layout Guidelines

For best overall performance, place all circuit components on the same side of the circuit board and as near as practical to the respective LDO pin connections. Place ground return connections to the input and output capacitor, and to the LDO ground pin as close to the GND pin as possible, connected by wide, component-side, copper surface area. The use of vias and long traces to create LDO component connections is strongly discouraged and negatively affects system performance. This grounding and layout scheme minimizes inductive parasitics, and thereby reduces load-current transients, minimizes noise, and increases circuit stability. A ground reference plane is also recommended and is either embedded in the printed circuit board (PCB) itself or located on the bottom side of the PCB opposite the components. This reference plane serves to assure accuracy of the output voltage, shields the LDO from noise, and functions similar to a thermal plane to spread (or sink) heat from the LDO device when connected to the thermal pad. In most applications, this ground plane is necessary to meet thermal requirements.

10.1.1 Board Layout Recommendations to Improve PSRR and Noise Performance

To improve ac performance (such as PSRR, output noise, and transient response), TI recommends that the board be designed with separate ground planes for V_{IN} and V_{OUT} , with each ground plane connected only at the GND pin of the device. In addition, the ground connection for the bypass capacitor must connect directly to the GND pin of the device.

10.2 Layout Examples



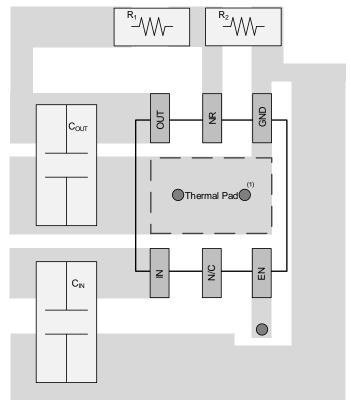
 Circles within thermal pad area indicate vias to other layers on the board, for electrical connections or thermal conduction.

Figure 37. Fixed Voltage Layout

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Layout Examples (continued)



(1) Circles within thermal pad area indicate vias to other layers on the board, for electrical connections or thermal conduction.

Figure 38. Adjustable Voltage Layout

10.3 Power Dissipation

The ability to remove heat from the die is different for each package type, presenting different considerations in the printed circuit board (PCB) layout. The PCB area around the device that is free of other components moves the heat from the device to the ambient air. Performance data for JEDEC low- and high-K boards are given in the *Thermal Information* table. Using heavier copper increases the effectiveness in removing heat from the device. The addition of plated through-holes to heat-dissipating layers also improves the heatsink effectiveness.

Power dissipation depends on input voltage and load conditions. Power dissipation (P_D) is equal to the product of the output current times the voltage drop across the output pass element (V_{IN} to V_{OUT}), and is approximated in Equation 4:

Product Folder Links: TPS717

$$P_{D} = (V_{IN} - V_{OUT}) \times I_{OUT}$$
(4)

(5)



Power Dissipation (continued)

A better method of estimating the thermal measure comes from using the thermal metrics Ψ_{JT} and Ψ_{JB} ; see the *Thermal Information* table. These metrics are a more accurate representation of the heat transfer characteristics of the die and the package than $R_{\theta JA}$. The junction temperature can be estimated with Equation 5.

$$\begin{split} \Psi_{JT} \colon & T_J = T_T + \Psi_{JT} \bullet P_D \\ \Psi_{JB} \colon & T_J = T_B + \Psi_{JB} \bullet P_D \end{split}$$

where

- P_D is the power dissipation given by Equation 4,
- T_T is the temperature at the center-top of the device package,
- T_B is the PCB temperature measured 1 mm away from the device package on the PCB surface.

NOTE

Both T_T and T_B can be measured on actual application boards using a thermo-gun (an infrared thermometer).

For more information about measuring T_T and T_B , see the application note *Using New Thermal Metrics* (SBVA025), available for download at www.ti.com.



11 Device and Documentation Support

11.1 Device Support

11.1.1 Development Support

11.1.1.1 Evaluation Module

An evaluation module (EVM) is available to assist in the initial circuit performance evaluation using the TPS717. The TPS717xxEVM-134 evaluation module (and related user's guide) can be requested at the Texas Instruments website through the product folders or purchased directly from the TI eStore.

11.1.2 Device Nomenclature

Table 4. Device Nomenclature (1)

| PRODUCT | V _{out} |
|-------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| TPS717 xx(x)yyyz | xx(x) is the nominal output voltage. For output voltages with a resolution of 100 mV, two digits are used in the ordering number; otherwise, three digits are used (for example, 28 = 2.8 V; 125 = 1.25 V). An 01 denotes an adjustable voltage version. yyy is the package designator. z is the package quantity. R is for a large reel (3000 pieces), T is for a small reel (250 pieces). |

⁽¹⁾ For the most current package and ordering information see the Package Option Addendum at the end of this document, or visit the device product folder on www.ti.com.

11.2 Documentation Support

11.2.1 Related Documentation

PMP10651 Test Results, TIDUAE4

TPS717xxEVM-134 Evaluation Module User's Guide, SLVU148

Using New Thermal Metrics, SBVA025

11.3 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E™ Online Community *TI's Engineer-to-Engineer (E2E) Community.* Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

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11.4 Trademarks

E2E is a trademark of Texas Instruments. Bluetooth is a registered trademark of Bluetooth SIG, Inc. All other trademarks are the property of their respective owners.

11.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

11.6 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.





2-Jun-2016

PACKAGING INFORMATION

| Orderable Device | Status | Package Type | Package Drawing | Pins | Package Qty | Eco Plan | Lead/Ball Finish (6) | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|--------|--------------|--------------------|------|----------------|----------------------------|----------------------|--------------------|--------------|-------------------------|---------|
| TPS71701DCKR | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | ВМТ | Sample |
| TPS71701DCKRG4 | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | ВМТ | Samples |
| TPS71701DCKT | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | ВМТ | Samples |
| TPS71701DCKTG4 | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | ВМТ | Samples |
| TPS71709DSER | ACTIVE | WSON | DSE | 6 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAUAG | Level-1-260C-UNLIM | -40 to 125 | FY | Samples |
| TPS71709DSERG4 | ACTIVE | WSON | DSE | 6 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAUAG | Level-1-260C-UNLIM | -40 to 125 | FY | Samples |
| TPS71709DSET | ACTIVE | WSON | DSE | 6 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAUAG | Level-1-260C-UNLIM | -40 to 125 | FY | Samples |
| TPS71709DSETG4 | ACTIVE | WSON | DSE | 6 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAUAG | Level-1-260C-UNLIM | -40 to 125 | FY | Samples |
| TPS71710DCKR | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BMU | Samples |
| TPS71710DCKRG4 | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BMU | Samples |
| TPS71710DCKT | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BMU | Samples |
| TPS71710DCKTG4 | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | ВМИ | Samples |
| TPS71710DRVR | ACTIVE | WSON | DRV | 6 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BMU | Samples |
| TPS71710DRVRG4 | ACTIVE | WSON | DRV | 6 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BMU | Samples |
| TPS71710DRVT | ACTIVE | WSON | DRV | 6 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BMU | Samples |
| TPS71711DCKR | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BRL | Samples |
| TPS71711DCKRG4 | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BRL | Samples |



2-Jun-2016

| Orderable Device | Status | Package Type | Package Drawing | Pins | Package Qty | Eco Plan | Lead/Ball Finish | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|--------|--------------|--------------------|------|----------------|----------------------------|------------------|--------------------|--------------|----------------------|---------|
| TPS71711DCKT | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BRL | Samples |
| TPS71711DCKTG4 | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BRL | Samples |
| TPS71712DCKR | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | CKE | Samples |
| TPS71712DCKRG4 | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | CKE | Samples |
| TPS71712DCKT | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | CKE | Samples |
| TPS71712DCKTG4 | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | CKE | Samples |
| TPS71713DCKR | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BMW | Samples |
| TPS71713DCKT | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BMW | Samples |
| TPS71713DCKTG4 | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BMW | Samples |
| TPS71715DCKR | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | CAA | Samples |
| TPS71715DCKT | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | CAA | Samples |
| TPS71715DCKTG4 | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | CAA | Samples |
| TPS717185DSER | ACTIVE | WSON | DSE | 6 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAUAG | Level-1-260C-UNLIM | -40 to 125 | КВ | Samples |
| TPS717185DSET | ACTIVE | WSON | DSE | 6 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAUAG | Level-1-260C-UNLIM | -40 to 125 | КВ | Samples |
| TPS71718DCKR | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | ВМХ | Samples |
| TPS71718DCKRG4 | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | ВМХ | Samples |
| TPS71718DCKT | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | ВМХ | Samples |
| TPS71718DCKTG4 | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BMX | Samples |





2-Jun-2016

| Orderable Device | Status | Package Type | Package Drawing | Pins | Package Qty | Eco Plan | Lead/Ball Finish | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|--------|--------------|--------------------|------|----------------|----------------------------|------------------|--------------------|--------------|----------------------|---------|
| TPS71718DSER | ACTIVE | WSON | DSE | 6 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAUAG | Level-1-260C-UNLIM | -40 to 125 | G6 | Samples |
| TPS71718DSERG4 | ACTIVE | WSON | DSE | 6 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAUAG | Level-1-260C-UNLIM | -40 to 125 | G6 | Sample |
| TPS71718DSET | ACTIVE | WSON | DSE | 6 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAUAG | Level-1-260C-UNLIM | -40 to 125 | G6 | Sample |
| TPS71719DCKR | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | CCZ | Sample |
| TPS71719DCKRG4 | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | CCZ | Samples |
| TPS71719DCKT | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | CCZ | Samples |
| TPS71719DCKTG4 | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | CCZ | Samples |
| TPS71721DCKR | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | NXL | Samples |
| TPS71721DCKT | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | NXL | Samples |
| TPS71725DCKR | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | CAF | Samples |
| TPS71725DCKRG4 | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | CAF | Samples |
| TPS71725DCKT | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | CAF | Samples |
| TPS71726DCKR | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BRK | Samples |
| TPS71726DCKT | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BRK | Samples |
| TPS71726DCKTG4 | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BRK | Samples |
| TPS71727DCKR | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BSC | Samples |
| TPS71727DCKT | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BSC | Samples |
| TPS71727DCKTG4 | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BSC | Samples |



2-Jun-2016

| Orderable Device | Status | Package Type | U | Pins | _ | Eco Plan | Lead/Ball Finish | MSL Peak Temp | Op Temp (°C) | Device Marking | Samples |
|------------------|--------|--------------|---------|------|------|----------------------------|------------------|--------------------|--------------|----------------|---------|
| | (1) | | Drawing | | Qty | (2) | (6) | (3) | | (4/5) | |
| TPS71727DSER | ACTIVE | WSON | DSE | 6 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAUAG | Level-1-260C-UNLIM | -40 to 125 | KU | Samples |
| TPS71727DSET | ACTIVE | WSON | DSE | 6 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAUAG | Level-1-260C-UNLIM | -40 to 125 | KU | Samples |
| TPS717285DCKR | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BRJ | Samples |
| TPS717285DCKT | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BRJ | Samples |
| TPS71728DCKR | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BMZ | Samples |
| TPS71728DCKRG4 | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BMZ | Samples |
| TPS71728DCKT | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BMZ | Samples |
| TPS71728DCKTG4 | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BMZ | Samples |
| TPS71728DSER | ACTIVE | WSON | DSE | 6 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAUAG | Level-1-260C-UNLIM | -40 to 125 | FU | Samples |
| TPS71728DSERG4 | ACTIVE | WSON | DSE | 6 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAUAG | Level-1-260C-UNLIM | -40 to 125 | FU | Samples |
| TPS71728DSET | ACTIVE | WSON | DSE | 6 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAUAG | Level-1-260C-UNLIM | -40 to 125 | FU | Samples |
| TPS71728DSETG4 | ACTIVE | WSON | DSE | 6 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAUAG | Level-1-260C-UNLIM | -40 to 125 | FU | Samples |
| TPS71729DCKR | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | CJR | Samples |
| TPS71729DCKT | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | CJR | Samples |
| TPS71730DCKR | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BNA | Samples |
| TPS71730DCKRG4 | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BNA | Samples |
| TPS71730DCKT | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BNA | Samples |
| TPS71730DCKTG4 | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BNA | Samples |





2-Jun-2016

| Orderable Device | Status | Package Type | _ | Pins | _ | Eco Plan | Lead/Ball Finish | MSL Peak Temp | Op Temp (°C) | Device Marking | Samples |
|------------------|--------|--------------|---------|------|------|----------------------------|------------------|--------------------|--------------|----------------|---------|
| | (1) | | Drawing | | Qty | (2) | (6) | (3) | | (4/5) | |
| TPS71733DCKR | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BNB | Samples |
| TPS71733DCKRG4 | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BNB | Samples |
| TPS71733DCKT | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BNB | Samples |
| TPS71733DCKTG4 | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BNB | Samples |
| TPS71733DRVR | ACTIVE | WSON | DRV | 6 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BNB | Samples |
| TPS71733DRVRG4 | ACTIVE | WSON | DRV | 6 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BNB | Samples |
| TPS71733DRVT | ACTIVE | WSON | DRV | 6 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BNB | Samples |
| TPS71733DRVTG4 | ACTIVE | WSON | DRV | 6 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | BNB | Samples |
| TPS71733DSER | ACTIVE | WSON | DSE | 6 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAUAG | Level-1-260C-UNLIM | -40 to 125 | FV | Samples |
| TPS71733DSET | ACTIVE | WSON | DSE | 6 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAUAG | Level-1-260C-UNLIM | -40 to 125 | FV | Samples |
| TPS71745DSER | ACTIVE | WSON | DSE | 6 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | GL | Samples |
| TPS71745DSET | ACTIVE | WSON | DSE | 6 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | GL | Samples |
| TPS71750DSER | ACTIVE | WSON | DSE | 6 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAUAG | Level-1-260C-UNLIM | -40 to 125 | PD | Samples |
| TPS71750DSET | ACTIVE | WSON | DSE | 6 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAUAG | Level-1-260C-UNLIM | -40 to 125 | PD | Samples |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.



PACKAGE OPTION ADDENDUM

2-Jun-2016

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF TPS717:

Automotive: TPS717-Q1

NOTE: Qualified Version Definitions:

Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

www.ti.com 3-Aug-2017

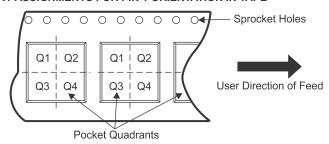
TAPE AND REEL INFORMATION



TAPE DIMENSIONS KO P1 BO Cavity A0

| A0 | Dimension designed to accommodate the component width |
|----|-----------------------------------------------------------|
| | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|-----------------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| TPS71701DCKR | SC70 | DCK | 5 | 3000 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71701DCKT | SC70 | DCK | 5 | 250 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71709DSER | WSON | DSE | 6 | 3000 | 179.0 | 8.4 | 1.8 | 1.8 | 1.0 | 4.0 | 8.0 | Q2 |
| TPS71709DSET | WSON | DSE | 6 | 250 | 179.0 | 8.4 | 1.8 | 1.8 | 1.0 | 4.0 | 8.0 | Q2 |
| TPS71710DCKR | SC70 | DCK | 5 | 3000 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71710DCKR | SC70 | DCK | 5 | 3000 | 179.0 | 8.4 | 2.25 | 2.4 | 1.22 | 4.0 | 8.0 | Q3 |
| TPS71710DCKT | SC70 | DCK | 5 | 250 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71710DCKT | SC70 | DCK | 5 | 250 | 179.0 | 8.4 | 2.25 | 2.4 | 1.22 | 4.0 | 8.0 | Q3 |
| TPS71710DRVR | WSON | DRV | 6 | 3000 | 179.0 | 8.4 | 2.2 | 2.2 | 1.2 | 4.0 | 8.0 | Q2 |
| TPS71710DRVT | WSON | DRV | 6 | 250 | 179.0 | 8.4 | 2.2 | 2.2 | 1.2 | 4.0 | 8.0 | Q2 |
| TPS71711DCKR | SC70 | DCK | 5 | 3000 | 179.0 | 8.4 | 2.25 | 2.4 | 1.22 | 4.0 | 8.0 | Q3 |
| TPS71711DCKR | SC70 | DCK | 5 | 3000 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71711DCKT | SC70 | DCK | 5 | 250 | 179.0 | 8.4 | 2.25 | 2.4 | 1.22 | 4.0 | 8.0 | Q3 |
| TPS71711DCKT | SC70 | DCK | 5 | 250 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71712DCKR | SC70 | DCK | 5 | 3000 | 179.0 | 8.4 | 2.25 | 2.4 | 1.22 | 4.0 | 8.0 | Q3 |
| TPS71712DCKR | SC70 | DCK | 5 | 3000 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71712DCKT | SC70 | DCK | 5 | 250 | 179.0 | 8.4 | 2.25 | 2.4 | 1.22 | 4.0 | 8.0 | Q3 |
| TPS71712DCKT | SC70 | DCK | 5 | 250 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |



| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|-----------------|--------------------|------|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| TPS71713DCKR | SC70 | DCK | 5 | 3000 | 179.0 | 8.4 | 2.25 | 2.4 | 1.22 | 4.0 | 8.0 | Q3 |
| TPS71713DCKR | SC70 | DCK | 5 | 3000 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71713DCKT | SC70 | DCK | 5 | 250 | 179.0 | 8.4 | 2.25 | 2.4 | 1.22 | 4.0 | 8.0 | Q3 |
| TPS71713DCKT | SC70 | DCK | 5 | 250 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71715DCKR | SC70 | DCK | 5 | 3000 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71715DCKR | SC70 | DCK | 5 | 3000 | 179.0 | 8.4 | 2.2 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71715DCKT | SC70 | DCK | 5 | 250 | 179.0 | 8.4 | 2.2 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71715DCKT | SC70 | DCK | 5 | 250 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS717185DSER | WSON | DSE | 6 | 3000 | 179.0 | 8.4 | 1.8 | 1.8 | 1.0 | 4.0 | 8.0 | Q2 |
| TPS717185DSET | WSON | DSE | 6 | 250 | 179.0 | 8.4 | 1.8 | 1.8 | 1.0 | 4.0 | 8.0 | Q2 |
| TPS71718DCKR | SC70 | DCK | 5 | 3000 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71718DCKR | SC70 | DCK | 5 | 3000 | 179.0 | 8.4 | 2.2 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71718DCKT | SC70 | DCK | 5 | 250 | 179.0 | 8.4 | 2.2 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71718DCKT | SC70 | DCK | 5 | 250 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71718DSER | WSON | DSE | 6 | 3000 | 179.0 | 8.4 | 1.8 | 1.8 | 1.0 | 4.0 | 8.0 | Q2 |
| TPS71718DSET | WSON | DSE | 6 | 250 | 179.0 | 8.4 | 1.8 | 1.8 | 1.0 | 4.0 | 8.0 | Q2 |
| TPS71719DCKR | SC70 | DCK | 5 | 3000 | 179.0 | 8.4 | 2.25 | 2.4 | 1.22 | 4.0 | 8.0 | Q3 |
| TPS71719DCKR | SC70 | DCK | 5 | 3000 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71719DCKT | SC70 | DCK | 5 | 250 | 179.0 | 8.4 | 2.25 | 2.4 | 1.22 | 4.0 | 8.0 | Q3 |
| TPS71719DCKT | SC70 | DCK | 5 | 250 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71721DCKR | SC70 | DCK | 5 | 3000 | 179.0 | 8.4 | 2.2 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71721DCKR | SC70 | DCK | 5 | 3000 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71721DCKT | SC70 | DCK | 5 | 250 | 179.0 | 8.4 | 2.2 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71721DCKT | SC70 | DCK | 5 | 250 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71725DCKR | SC70 | DCK | 5 | 3000 | 179.0 | 8.4 | 2.2 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71725DCKR | SC70 | DCK | 5 | 3000 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71725DCKT | SC70 | DCK | 5 | 250 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71725DCKT | SC70 | DCK | 5 | 250 | 179.0 | 8.4 | 2.2 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71726DCKR | SC70 | DCK | 5 | 3000 | 179.0 | 8.4 | 2.25 | 2.4 | 1.22 | 4.0 | 8.0 | Q3 |
| TPS71726DCKR | SC70 | DCK | 5 | 3000 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71726DCKT | SC70 | DCK | 5 | 250 | 179.0 | 8.4 | 2.25 | 2.4 | 1.22 | 4.0 | 8.0 | Q3 |
| TPS71726DCKT | SC70 | DCK | 5 | 250 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71727DCKR | SC70 | DCK | 5 | 3000 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71727DCKR | SC70 | DCK | 5 | 3000 | 179.0 | 8.4 | 2.25 | 2.4 | 1.22 | 4.0 | 8.0 | Q3 |
| TPS71727DCKT | SC70 | DCK | 5 | 250 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71727DCKT | SC70 | DCK | 5 | 250 | 179.0 | 8.4 | 2.25 | 2.4 | 1.22 | 4.0 | 8.0 | Q3 |
| TPS71727DSER | WSON | DSE | 6 | 3000 | 179.0 | 8.4 | 1.8 | 1.8 | 1.0 | 4.0 | 8.0 | Q2 |
| TPS71727DSET | WSON | DSE | 6 | 250 | 179.0 | 8.4 | 1.8 | 1.8 | 1.0 | 4.0 | 8.0 | Q2 |
| TPS717285DCKR | SC70 | DCK | 5 | 3000 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS717285DCKR | SC70 | DCK | 5 | 3000 | 179.0 | 8.4 | 2.25 | 2.4 | 1.22 | 4.0 | 8.0 | Q3 |
| TPS717285DCKT | SC70 | DCK | 5 | 250 | 179.0 | 8.4 | 2.25 | 2.4 | 1.22 | 4.0 | 8.0 | Q3 |
| TPS717285DCKT | SC70 | DCK | 5 | 250 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71728DCKR | SC70 | DCK | 5 | 3000 | 179.0 | 8.4 | 2.2 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |



| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|-----------------|--------------------|------|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| TPS71728DCKR | SC70 | DCK | 5 | 3000 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71728DCKT | SC70 | DCK | 5 | 250 | 179.0 | 8.4 | 2.25 | 2.4 | 1.22 | 4.0 | 8.0 | Q3 |
| TPS71728DCKT | SC70 | DCK | 5 | 250 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71728DSER | WSON | DSE | 6 | 3000 | 179.0 | 8.4 | 1.8 | 1.8 | 1.0 | 4.0 | 8.0 | Q2 |
| TPS71728DSET | WSON | DSE | 6 | 250 | 179.0 | 8.4 | 1.8 | 1.8 | 1.0 | 4.0 | 8.0 | Q2 |
| TPS71729DCKR | SC70 | DCK | 5 | 3000 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71729DCKR | SC70 | DCK | 5 | 3000 | 179.0 | 8.4 | 2.25 | 2.4 | 1.22 | 4.0 | 8.0 | Q3 |
| TPS71729DCKT | SC70 | DCK | 5 | 250 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71729DCKT | SC70 | DCK | 5 | 250 | 179.0 | 8.4 | 2.25 | 2.4 | 1.22 | 4.0 | 8.0 | Q3 |
| TPS71730DCKR | SC70 | DCK | 5 | 3000 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71730DCKR | SC70 | DCK | 5 | 3000 | 179.0 | 8.4 | 2.25 | 2.4 | 1.22 | 4.0 | 8.0 | Q3 |
| TPS71730DCKT | SC70 | DCK | 5 | 250 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71730DCKT | SC70 | DCK | 5 | 250 | 179.0 | 8.4 | 2.25 | 2.4 | 1.22 | 4.0 | 8.0 | Q3 |
| TPS71733DCKR | SC70 | DCK | 5 | 3000 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71733DCKR | SC70 | DCK | 5 | 3000 | 179.0 | 8.4 | 2.2 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71733DCKT | SC70 | DCK | 5 | 250 | 179.0 | 8.4 | 2.25 | 2.4 | 1.22 | 4.0 | 8.0 | Q3 |
| TPS71733DCKT | SC70 | DCK | 5 | 250 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TPS71733DRVR | WSON | DRV | 6 | 3000 | 179.0 | 8.4 | 2.2 | 2.2 | 1.2 | 4.0 | 8.0 | Q2 |
| TPS71733DRVT | WSON | DRV | 6 | 250 | 179.0 | 8.4 | 2.2 | 2.2 | 1.2 | 4.0 | 8.0 | Q2 |
| TPS71733DSER | WSON | DSE | 6 | 3000 | 179.0 | 8.4 | 1.8 | 1.8 | 1.0 | 4.0 | 8.0 | Q2 |
| TPS71733DSET | WSON | DSE | 6 | 250 | 179.0 | 8.4 | 1.8 | 1.8 | 1.0 | 4.0 | 8.0 | Q2 |
| TPS71745DSER | WSON | DSE | 6 | 3000 | 179.0 | 8.4 | 1.8 | 1.8 | 1.0 | 4.0 | 8.0 | Q2 |
| TPS71745DSET | WSON | DSE | 6 | 250 | 179.0 | 8.4 | 1.8 | 1.8 | 1.0 | 4.0 | 8.0 | Q2 |
| TPS71750DSER | WSON | DSE | 6 | 3000 | 179.0 | 8.4 | 1.8 | 1.8 | 1.0 | 4.0 | 8.0 | Q2 |
| TPS71750DSET | WSON | DSE | 6 | 250 | 179.0 | 8.4 | 1.8 | 1.8 | 1.0 | 4.0 | 8.0 | Q2 |





*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TPS71701DCKR | SC70 | DCK | 5 | 3000 | 180.0 | 180.0 | 18.0 |
| TPS71701DCKT | SC70 | DCK | 5 | 250 | 180.0 | 180.0 | 18.0 |
| TPS71709DSER | WSON | DSE | 6 | 3000 | 203.0 | 203.0 | 35.0 |
| TPS71709DSET | WSON | DSE | 6 | 250 | 203.0 | 203.0 | 35.0 |
| TPS71710DCKR | SC70 | DCK | 5 | 3000 | 180.0 | 180.0 | 18.0 |
| TPS71710DCKR | SC70 | DCK | 5 | 3000 | 203.0 | 203.0 | 35.0 |
| TPS71710DCKT | SC70 | DCK | 5 | 250 | 340.0 | 340.0 | 38.0 |
| TPS71710DCKT | SC70 | DCK | 5 | 250 | 203.0 | 203.0 | 35.0 |
| TPS71710DRVR | WSON | DRV | 6 | 3000 | 203.0 | 203.0 | 35.0 |
| TPS71710DRVT | WSON | DRV | 6 | 250 | 203.0 | 203.0 | 35.0 |
| TPS71711DCKR | SC70 | DCK | 5 | 3000 | 203.0 | 203.0 | 35.0 |
| TPS71711DCKR | SC70 | DCK | 5 | 3000 | 180.0 | 180.0 | 18.0 |
| TPS71711DCKT | SC70 | DCK | 5 | 250 | 203.0 | 203.0 | 35.0 |
| TPS71711DCKT | SC70 | DCK | 5 | 250 | 340.0 | 340.0 | 38.0 |
| TPS71712DCKR | SC70 | DCK | 5 | 3000 | 203.0 | 203.0 | 35.0 |
| TPS71712DCKR | SC70 | DCK | 5 | 3000 | 180.0 | 180.0 | 18.0 |
| TPS71712DCKT | SC70 | DCK | 5 | 250 | 203.0 | 203.0 | 35.0 |
| TPS71712DCKT | SC70 | DCK | 5 | 250 | 180.0 | 180.0 | 18.0 |
| TPS71713DCKR | SC70 | DCK | 5 | 3000 | 203.0 | 203.0 | 35.0 |
| TPS71713DCKR | SC70 | DCK | 5 | 3000 | 180.0 | 180.0 | 18.0 |



| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TPS71713DCKT | SC70 | DCK | 5 | 250 | 203.0 | 203.0 | 35.0 |
| TPS71713DCKT | SC70 | DCK | 5 | 250 | 180.0 | 180.0 | 18.0 |
| TPS71715DCKR | SC70 | DCK | 5 | 3000 | 180.0 | 180.0 | 18.0 |
| TPS71715DCKR | SC70 | DCK | 5 | 3000 | 203.0 | 203.0 | 35.0 |
| TPS71715DCKT | SC70 | DCK | 5 | 250 | 203.0 | 203.0 | 35.0 |
| TPS71715DCKT | SC70 | DCK | 5 | 250 | 180.0 | 180.0 | 18.0 |
| TPS717185DSER | WSON | DSE | 6 | 3000 | 203.0 | 203.0 | 35.0 |
| TPS717185DSET | WSON | DSE | 6 | 250 | 203.0 | 203.0 | 35.0 |
| TPS71718DCKR | SC70 | DCK | 5 | 3000 | 180.0 | 180.0 | 18.0 |
| TPS71718DCKR | SC70 | DCK | 5 | 3000 | 203.0 | 203.0 | 35.0 |
| TPS71718DCKT | SC70 | DCK | 5 | 250 | 203.0 | 203.0 | 35.0 |
| TPS71718DCKT | SC70 | DCK | 5 | 250 | 180.0 | 180.0 | 18.0 |
| TPS71718DSER | WSON | DSE | 6 | 3000 | 203.0 | 203.0 | 35.0 |
| TPS71718DSET | WSON | DSE | 6 | 250 | 203.0 | 203.0 | 35.0 |
| TPS71719DCKR | SC70 | DCK | 5 | 3000 | 203.0 | 203.0 | 35.0 |
| TPS71719DCKR | SC70 | DCK | 5 | 3000 | 180.0 | 180.0 | 18.0 |
| TPS71719DCKT | SC70 | DCK | 5 | 250 | 203.0 | 203.0 | 35.0 |
| TPS71719DCKT | SC70 | DCK | 5 | 250 | 180.0 | 180.0 | 18.0 |
| TPS71721DCKR | SC70 | DCK | 5 | 3000 | 203.0 | 203.0 | 35.0 |
| TPS71721DCKR | SC70 | DCK | 5 | 3000 | 180.0 | 180.0 | 18.0 |
| TPS71721DCKT | SC70 | DCK | 5 | 250 | 203.0 | 203.0 | 35.0 |
| TPS71721DCKT | SC70 | DCK | 5 | 250 | 180.0 | 180.0 | 18.0 |
| TPS71725DCKR | SC70 | DCK | 5 | 3000 | 203.0 | 203.0 | 35.0 |
| TPS71725DCKR | SC70 | DCK | 5 | 3000 | 180.0 | 180.0 | 18.0 |
| TPS71725DCKT | SC70 | DCK | 5 | 250 | 180.0 | 180.0 | 18.0 |
| TPS71725DCKT | SC70 | DCK | 5 | 250 | 203.0 | 203.0 | 35.0 |
| TPS71726DCKR | SC70 | DCK | 5 | 3000 | 203.0 | 203.0 | 35.0 |
| TPS71726DCKR | SC70 | DCK | 5 | 3000 | 180.0 | 180.0 | 18.0 |
| TPS71726DCKT | SC70 | DCK | 5 | 250 | 203.0 | 203.0 | 35.0 |
| TPS71726DCKT | SC70 | DCK | 5 | 250 | 180.0 | 180.0 | 18.0 |
| TPS71727DCKR | SC70 | DCK | 5 | 3000 | 180.0 | 180.0 | 18.0 |
| TPS71727DCKR | SC70 | DCK | 5 | 3000 | 203.0 | 203.0 | 35.0 |
| TPS71727DCKT | SC70 | DCK | 5 | 250 | 180.0 | 180.0 | 18.0 |
| TPS71727DCKT | SC70 | DCK | 5 | 250 | 203.0 | 203.0 | 35.0 |
| TPS71727DSER | WSON | DSE | 6 | 3000 | 203.0 | 203.0 | 35.0 |
| TPS71727DSET | WSON | DSE | 6 | 250 | 203.0 | 203.0 | 35.0 |
| TPS717285DCKR | SC70 | DCK | 5 | 3000 | 180.0 | 180.0 | 18.0 |
| TPS717285DCKR | SC70 | DCK | 5 | 3000 | 203.0 | 203.0 | 35.0 |
| TPS717285DCKT | SC70 | DCK | 5 | 250 | 203.0 | 203.0 | 35.0 |
| TPS717285DCKT | SC70 | DCK | 5 | 250 | 180.0 | 180.0 | 18.0 |
| TPS71728DCKR | SC70 | DCK | 5 | 3000 | 203.0 | 203.0 | 35.0 |
| TPS71728DCKR | SC70 | DCK | 5 | 3000 | 180.0 | 180.0 | 18.0 |
| TPS71728DCKT | SC70 | DCK | 5 | 250 | 203.0 | 203.0 | 35.0 |
| TPS71728DCKT | SC70 | DCK | 5 | 250 | 180.0 | 180.0 | 18.0 |



| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TPS71728DSER | WSON | DSE | 6 | 3000 | 203.0 | 203.0 | 35.0 |
| TPS71728DSET | WSON | DSE | 6 | 250 | 203.0 | 203.0 | 35.0 |
| TPS71729DCKR | SC70 | DCK | 5 | 3000 | 180.0 | 180.0 | 18.0 |
| TPS71729DCKR | SC70 | DCK | 5 | 3000 | 203.0 | 203.0 | 35.0 |
| TPS71729DCKT | SC70 | DCK | 5 | 250 | 180.0 | 180.0 | 18.0 |
| TPS71729DCKT | SC70 | DCK | 5 | 250 | 203.0 | 203.0 | 35.0 |
| TPS71730DCKR | SC70 | DCK | 5 | 3000 | 180.0 | 180.0 | 18.0 |
| TPS71730DCKR | SC70 | DCK | 5 | 3000 | 203.0 | 203.0 | 35.0 |
| TPS71730DCKT | SC70 | DCK | 5 | 250 | 180.0 | 180.0 | 18.0 |
| TPS71730DCKT | SC70 | DCK | 5 | 250 | 203.0 | 203.0 | 35.0 |
| TPS71733DCKR | SC70 | DCK | 5 | 3000 | 180.0 | 180.0 | 18.0 |
| TPS71733DCKR | SC70 | DCK | 5 | 3000 | 203.0 | 203.0 | 35.0 |
| TPS71733DCKT | SC70 | DCK | 5 | 250 | 203.0 | 203.0 | 35.0 |
| TPS71733DCKT | SC70 | DCK | 5 | 250 | 180.0 | 180.0 | 18.0 |
| TPS71733DRVR | WSON | DRV | 6 | 3000 | 203.0 | 203.0 | 35.0 |
| TPS71733DRVT | WSON | DRV | 6 | 250 | 203.0 | 203.0 | 35.0 |
| TPS71733DSER | WSON | DSE | 6 | 3000 | 203.0 | 203.0 | 35.0 |
| TPS71733DSET | WSON | DSE | 6 | 250 | 203.0 | 203.0 | 35.0 |
| TPS71745DSER | WSON | DSE | 6 | 3000 | 203.0 | 203.0 | 35.0 |
| TPS71745DSET | WSON | DSE | 6 | 250 | 203.0 | 203.0 | 35.0 |
| TPS71750DSER | WSON | DSE | 6 | 3000 | 203.0 | 203.0 | 35.0 |
| TPS71750DSET | WSON | DSE | 6 | 250 | 203.0 | 203.0 | 35.0 |

DCK (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Falls within JEDEC MO-203 variation AA.



DCK (R-PDSO-G5)

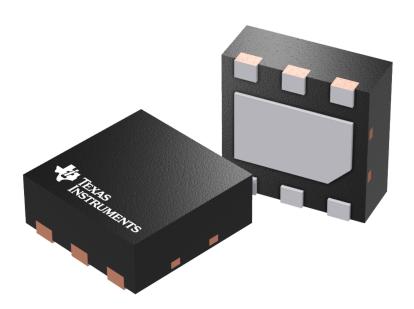
PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
- D. Publication IPC-7351 is recommended for alternate designs.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.





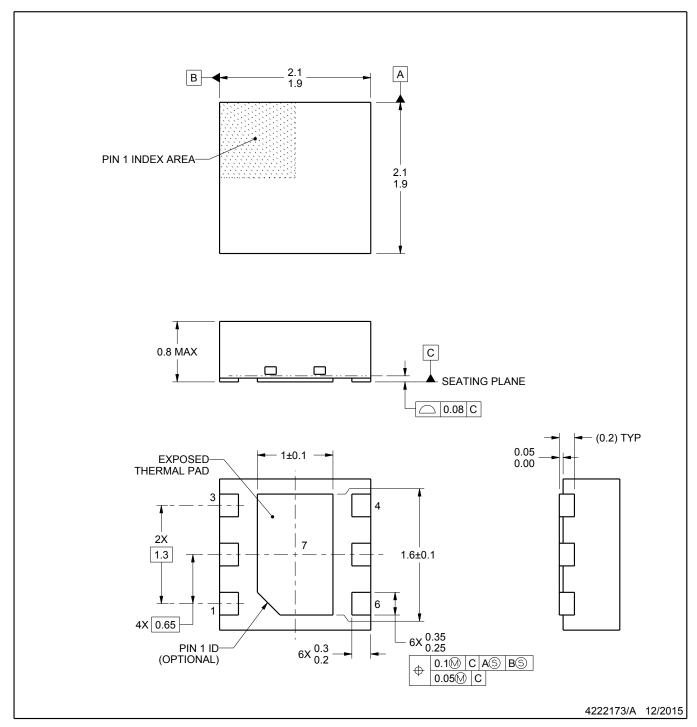
Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4206925/F





PLASTIC SMALL OUTLINE - NO LEAD



NOTES:

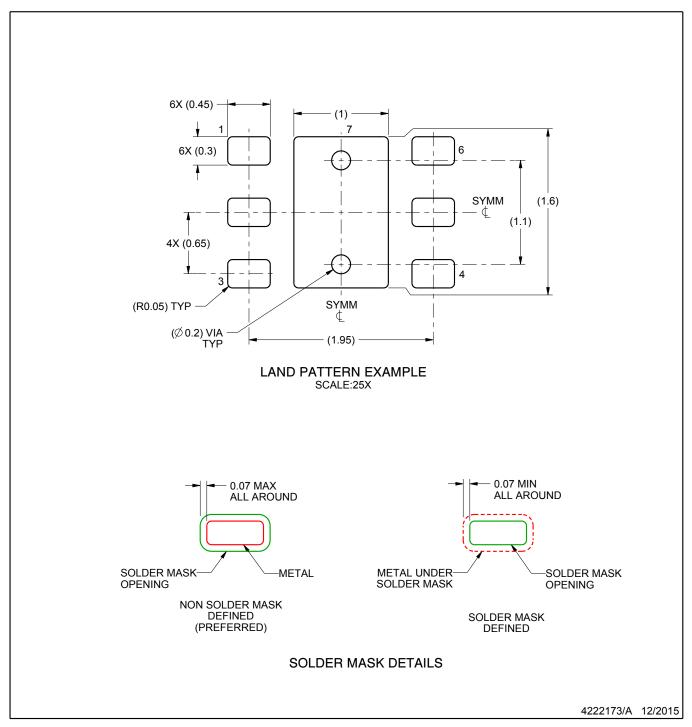
- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



PLASTIC SMALL OUTLINE - NO LEAD



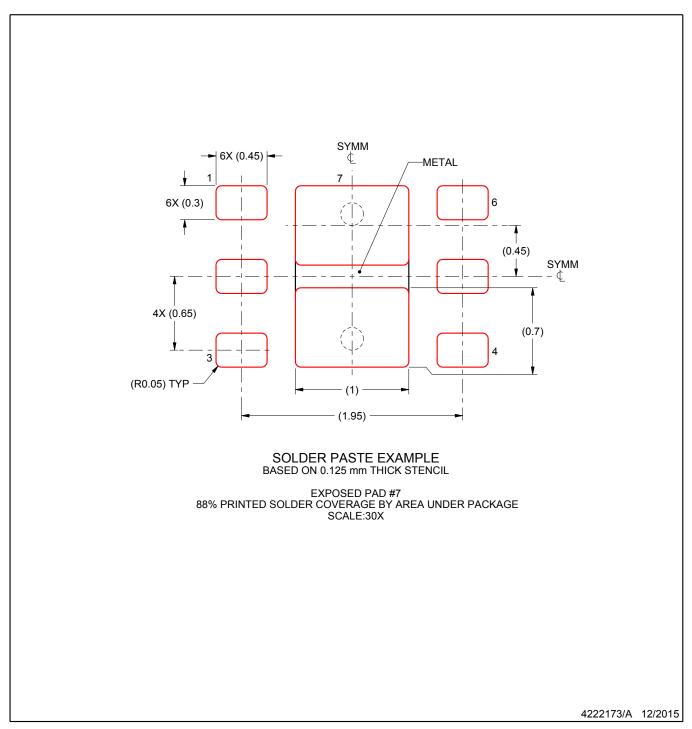
NOTES: (continued)

- 4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).

 5. Vias are optional depending on application, refer to device data sheet. If some or all are implemented, recommended via locations are shown.



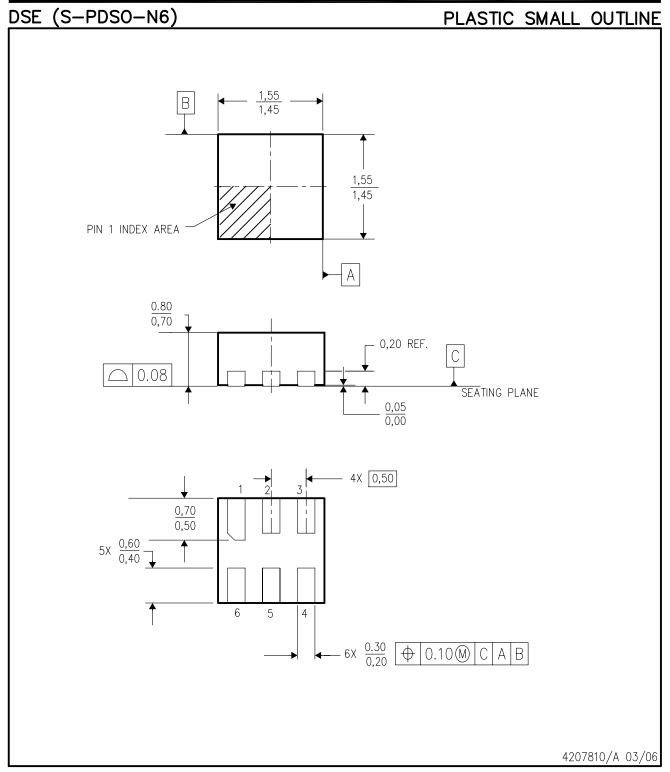
PLASTIC SMALL OUTLINE - NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.





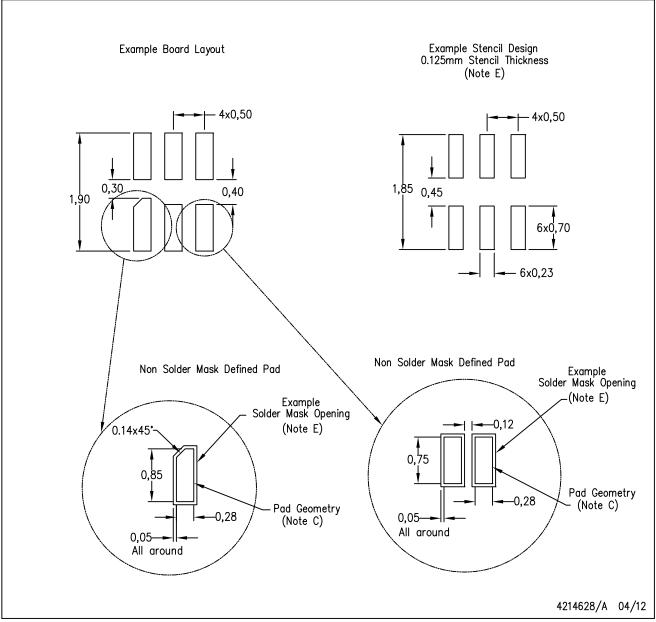
NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Small Outline No-Lead (SON) package configuration.
- D. This package is lead-free.



DSE (S-PWSON-N6)

PLASTIC SMALL OUTLINE NO-LEAD



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
- E. Customers should contact their board fabrication site for solder mask tolerances.



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